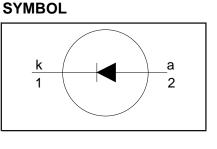
Rectifier diodes fast, soft-recovery

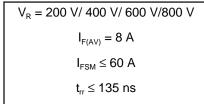
BY229F, BY229X series

FEATURES

- Low forward volt drop
- Fast switching
- Soft recovery characteristic
 High thermal cycling performance
 Isolated mounting tab



QUICK REFERENCE DATA



SOD113

GENERAL DESCRIPTION

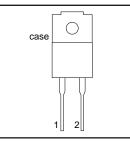
Glass-passivated double diffused rectifier diodes featuring low forward voltage drop, fast reverse recovery and soft recovery characteristic. The devices are intended for use in TV receivers, monitors and switched mode power supplies.

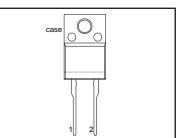
The BY229F series is supplied in the conventional leaded SOD100 package. The BY229X series is supplied in the conventional leaded SOD113 package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	
tab	isolated	

SOD100





LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MA	٩X.		UNIT
V _{RSM}	Peak non-repetitive reverse	BY229F- / BY229X-	-	200 200	400 400	600 600	800 800	V
V _{RRM} V _{RWM}	voltage Peak repetitive reverse voltage Crest working reverse voltage		-	200 150	400 300	600 500	800 600	V V
V _R	Continuous reverse voltage		-	150	300	500	600	V
I _{F(AV)}	Average forward current ¹	square wave; δ = 0.5; T _{hs} ≤ 83 °C	-		8	3		A
		siñusoidal; a = 1.57; T _{hs} ≤ 90 °C	-		7	7		A
I _{F(RMS)}	RMS forward current	10	-		1	1		A
I _{FRM}	Peak repetitive forward current	t = 25 μs; δ = 0.5; Τ _{bs} ≤ 83 °C	-		1	6		A
I _{FSM}	Peak non-repetitive forward	t = 10 ms	-			0		А
	current	t = 8.3 ms sinusoidal; T _j = 150 °C prior to surge; with reapplied V _{RWM(max)}	-		6	6		A
l ² t	I ² t for fusing	t = 10 ms	-			8		A²s °C
T _{stg} T _j	Storage temperature Operating junction temperature		-40 -			50 50		Û° Û

1. Neglecting switching and reverse current losses.

Rectifier diodes fast, soft-recovery

BY229F, BY229X series

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Peak isolation voltage from both terminals to external heatsink	SOD100 package; R.H. \leq 65%; clean and dustfree	-	-	1500	V
V _{isol}	R.M.S. isolation voltage from both terminals to external heatsink	SOD113 package; f = 50-60 Hz; sinusoidal waveform; R.H. \leq 65%; clean and dustfree	-	-	2500	V
C _{isol}	Capacitance from pin 1 to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs} R _{th j-a}	heatsink	with heatsink compound without heatsink compound in free air.		- - 55	4.8 7.2 -	K/W K/W K/W

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 20 A	-	1.5	1.85	V
I _R	Reverse current	V _R = V _{RWM} ; T _j = 125 °C		0.1	0.4	mA

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{rr} Q _s dI _R ∕dt	Reverse recovery time Reverse recovery charge Maximum slope of the reverse recovery current	$\begin{array}{l} I_{F}=1 \text{ A}; V_{R} \geq 30 \text{ V}; \text{ -dI}_{F}/\text{dt}=50 \text{A}/\mu\text{s} \\ I_{F}=2 \text{A}; V_{R} \geq 30 \text{V}; \text{ -dI}_{F}/\text{dt}=20 \text{A}/\mu\text{s} \\ I_{F}=2 \text{A}; \text{ -dI}_{F}/\text{dt}=20 \text{A}/\mu\text{s} \end{array}$	- - -	100 0.5 50	135 0.7 60	ns μC A/μs

BY229F, BY229X series

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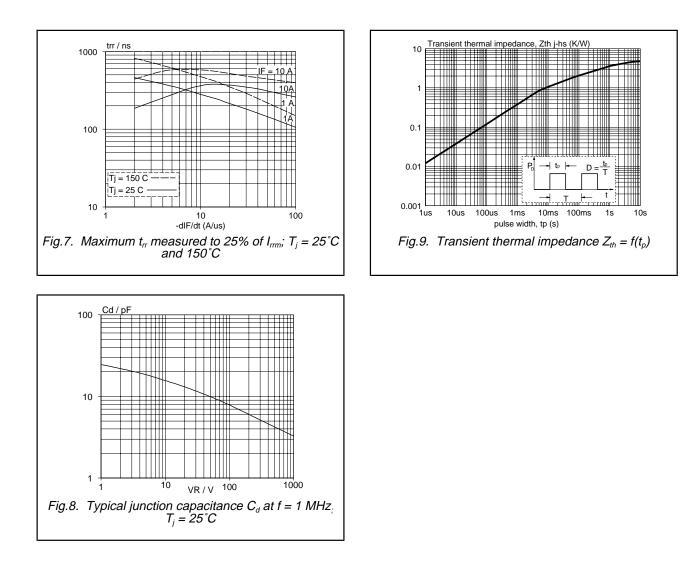
– dl _F IFS(RMS) / A 80 1_F dt 70 IFSM 60 trr 50 time 40 30 Qs 100% 20 25% 10 I R l rrm 0 + 1ms 0.1s 10ms 1s 10s tp/s Fig.4. Maximum non-repetitive rms forward current. $I_F = f(t_p)$; sinusoidal current waveform; $T_j = 150^{\circ}$ C prior to surge with reapplied V_{RWM} . Fig.1. Definition of t_{rr}, Q_s and I_{rrm} Ths(max) / C IF / A PF/W 30 20 54 D = 1.0= 1.25 \ Ti = 150 C= 25 C 78 15 0 20 0 102 10 0.1 10 $D = \frac{t_0}{T}$ tp 126 5 150 0 0 ò 0.5 1.5 6 IF(AV) / A 8 1 VF / V 4 10 12 Λ Fig.2. Maximum forward dissipation, $P_F = f(I_{F(AV)})$; square wave current waveform; parameter D = dutycycle = t_p/T . Fig.5. Typical and maximum forward characteristic; $I_F = f(V_F)$; parameter T_j Ths(max) / C Qs / uC Tj = 150 C PF/W 15 10 78 Vo = 1.25 V Tj = 25 C a = 1.57-Rs = 0.03 Ohms 10 A 1.9 2.2 102 10 .2.8 1 5 126 150 0.1 0 10 4 6 8 100 2 -dIF/dt (A/us) IF(AV) / A Fig.3. Maximum forward dissipation, $P_F = f(I_{F(AV)})$; sinusoidal current waveform; parameter a = formfactor = $I_{F(RMS)}/I_{F(AV)}$. Fig.6. Maximum Q_s at $T_i = 25^{\circ}C$ and $150^{\circ}C$

September 1998

Product specification

Rectifier diodes fast, soft-recovery

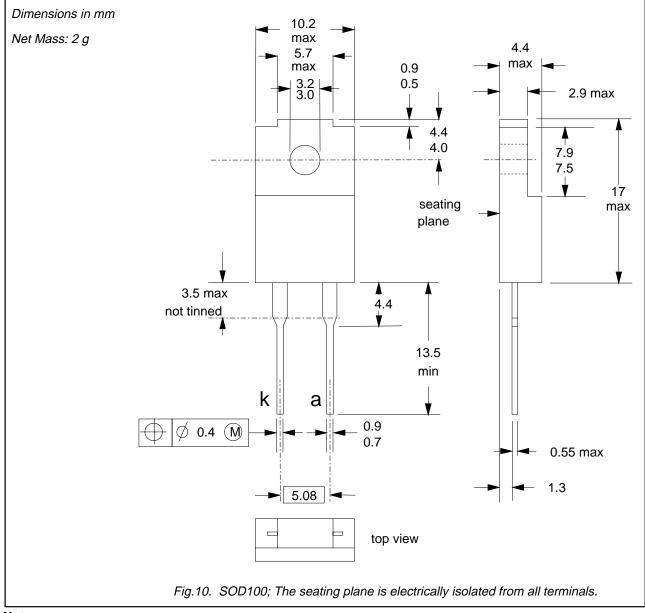
BY229F, BY229X series



Rectifier diodes fast, soft-recovery

BY229F, BY229X series

MECHANICAL DATA



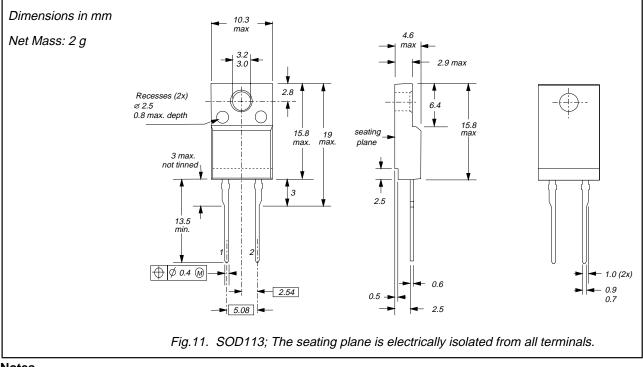
Notes

Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

Rectifier diodes fast, soft-recovery

BY229F, BY229X series

MECHANICAL DATA



Notes

Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

Rectifier diodes fast, soft-recovery

BY229F, BY229X series

DEFINITIONS

Data sheet status					
Objective specification This data sheet contains target or goal specifications for product development.					
Preliminary specification This data sheet contains preliminary data; supplementary data may be published later.					
Product specification	This data sheet contains final product specifications.				
Limiting values					
or more of the limiting val operation of the device at	in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one lues may cause permanent damage to the device. These are stress ratings only and t these or at any other conditions above those given in the Characteristics sections of applied. Exposure to limiting values for extended periods may affect device reliability.				
Application information					
Where application information is given, it is advisory and does not form part of the specification.					
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